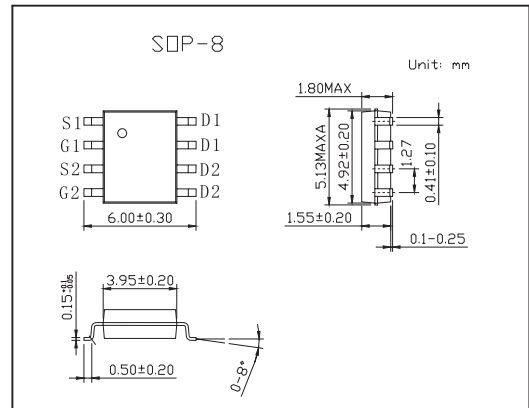
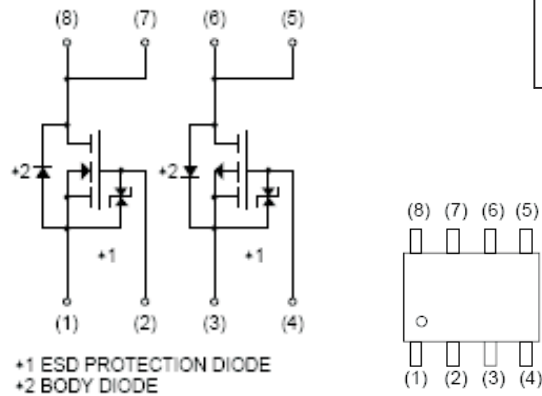


Switching

KP8M8

■ Features

- Low on-resistance.
- Built-in G-S Protection Diode.
- Small and Surface Mount Package.
- Power switching, DC / DC converter.

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-source voltage	V_{bss}	30	-30	V
Gate-source voltage	V_{gss}	20	-20	V
Drain current Continuous	I_D	± 6.0	± 4.5	A
Drain current Pulsed *	I_{DP}	± 24	± 18	A
Source current (Body diode) Continuous	I_S	1.6	-1.6	A
Source current (Body diode) Pulsed *	I_{SP}	20	-18	A
Total power dissipation	P_D	2		W
Channel temperature	T_{ch}	150		$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150		$^\circ\text{C}$
Channel to ambient	$R_{th(ch-a)}$	62.5		$^\circ\text{C/W}$

* $P_w \leq 10 \mu\text{s}$, Duty cycle $\leq 1\%$

KP8M8

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Gate-source leakage	I _{GSS}	V _{GS} =20V, V _{DS} =0V			10	μA
		V _{GS} =-20V, V _{DS} =0V			-10	
Drain-source breakdown voltage	V _{(BR) DSS}	I _D =1mA, V _{GS} =0V	30			V
		I _D =-1mA, V _{GS} =0V	-30			
Zero gate voltage drain current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1	μA
		V _{DS} =-30V, V _{GS} =0V			-1	
Gate threshold voltage	V _{GS (th)}	V _{DS} =10V, I _D =1mA	1.0		2.5	V
		V _{DS} =-10V, I _D =-1mA	-1.0		-2.5	
Static drain-source on-state resistance	R _{DS (on)}	I _D =6.0A, V _{GS} =10A		21	30	mΩ
		I _D =6.0A, V _{GS} =4.5V		30	42	
		I _D =6.0A, V _{GS} =4V		33	47	
Static drain-source on-state resistance	R _{DS (on)}	I _D =-4.5A, V _{GS} =-10A		40	56	mΩ
		I _D =-2.5A, V _{GS} =-4.5V		57	80	
		I _D =-2.5A, V _{GS} =-4.0V		65	90	
Forward transfer admittance	Y _{fs}	I _D =6.0A, V _{DS} =10V	4.0			S
		I _D =-2.5A, V _{DS} =-10V	3.5			
Input capacitance	C _{iss}	N-Channel V _{DS} =10V, V _{GS} =0V, f=1MHz	N-Ch	520		pF
			P-Ch	850		
Output capacitance	C _{oss}	P-Channel	N-Ch	150		pF
			P-Ch	190		
Reverse transfer capacitance	C _{rss}	V _{DS} =-10V, V _{GS} =0V, f=1MHz	N-Ch	95		pF
			P-Ch	120		
Turn-on delay time	t _{d (on)}	I _D =3A, V _{DD} =15V	N-Ch	9		ns
			P-Ch	10		
Rise time	t _r	N-Channel V _{GS} =10V, R _L =5.0Ω, R _G =10Ω	N-Ch	21		ns
			P-Ch	25		
Turn-off delay time	t _{d (off)}	P-Channel V _{GS} =-10V, R _L =6.0Ω, R _G =10Ω	N-Ch	36		ns
			P-Ch	60		
Fall time	t _f	V _{GS} =-10V, R _L =6.0Ω, R _G =10Ω	N-Ch	13		ns
			P-Ch	25		
Total gate charge	Q _g	N-Channel V _{DD} =15V, V _{GS} =5V, I _D =6.0A	N-Ch	7.2	10.1	nC
			P-Ch	8.5		
Gate-source charge	Q _{gs}	P-Channel V _{DD} =-15V, V _{GS} =-5V, I _D =-4.5A	N-Ch	1.8		nC
			P-Ch	2.5		
Gate-drain charge	Q _{gd}	V _{DD} =-15V, V _{GS} =-5V, I _D =-4.5A	N-Ch	2.8		nC
			P-Ch	3.0		
Forward voltage	V _{SD}	I _S =6.4A, V _{GS} =0V			1.2	V
		I _S =-1.6A, V _{GS} =0V			-1.2	